

Stanyl® TC502 PA46-GF15

Thermal conductive material

Print Date: 2025-12-04

Stanyl® TC502 is thermal conductive high heat polyamide designed for thermal management of electrical components with demanding conductivity levels.

PROPERTIES	TYPICAL DATA	UNIT	TEST METHOD
RHEOLOGICAL PROPERTIES	DRY / COND		
Molding shrinkage (parallel)	0.6 / *	%	ISO 294-4
Molding shrinkage (normal)	1.2 / *	%	ISO 294-4
MECHANICAL PROPERTIES	DRY / COND		
Tensile modulus	10000 / 4500	MPa	ISO 527-1/-2
Tensile modulus (120°C)	3300 / -	MPa	ISO 527-1/-2
Tensile modulus (160°C)	2800	MPa	ISO 527-1/-2
Tensile modulus (180°C)	2500	MPa	ISO 527-1/-2
Stress at break	65 / 45	MPa	ISO 527-1/-2
Stress at break (120°C)	33 / –	MPa	ISO 527-1/-2
Stress at break (160°C)	27	MPa	ISO 527-1/-2
Stress at break (180°C)	23	MPa	ISO 527-1/-2
Strain at break	1/2	%	ISO 527-1/-2
Strain at break (120°C)	2/-	%	ISO 527-1/-2
Strain at break (160°C)	2.1	%	ISO 527-1/-2
Strain at break (180°C)	2.1	%	ISO 527-1/-2
Flexural modulus	9400 / 5200	MPa	ISO 178
Flexural modulus (120°C)	3700	MPa	ISO 178
Flexural modulus (160°C)	3200	MPa	ISO 178
Flexural strength	110 / 75	MPa	ISO 178
Flexural strength (120°C)	60	MPa	ISO 178

Seller represents and warrants exclusively that on the date of delivery by Seller the product shall be in conformity with the specifications agreed upon. Seller makes no other representations or

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Property Data

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PROPERTIES	TYPICAL DATA	UNIT	TEST METHOD
Flexural strength (160°C)	45	MPa	ISO 178
Charpy impact strength (+23°C)	10 / 13	kJ/m²	ISO 179/1eU
Charpy impact strength (-30°C)	10 / 10	kJ/m²	ISO 179/1eU
Charpy notched impact strength (+23°C)	4/6	kJ/m²	ISO 179/1eA
Charpy notched impact strength (-30°C)	4 / 4	kJ/m²	ISO 179/1eA
THERMAL PROPERTIES	DRY / COND		
Melting temperature (10°C/min)	295 / *	°C	ISO 11357-1/-3
Coeff. of linear therm. expansion (parallel)	0.25	E-4/°C	ASTM D696
Coeff. of linear therm. expansion (normal)	0.35	E-4/°C	ASTM D696
Thermal conductivity in plane	14	W/(m K)	ASTM E1461
Thermal conductivity through plane	2.1	W/(m K)	ASTM E1461
ELECTRICAL PROPERTIES	DRY / COND		
Volume resistivity	10000 / -	Ohm*m	IEC 62631-3-1
OTHER PROPERTIES	DRY / COND		
Humidity absorption	1.9 / *	%	Sim. to ISO 62
Density	1480 / -	kg/m³	ISO 1183

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Seller is not responsible or liable for the design of the products of the Customer and it is the responsibility of the Customer to determine that the Seller's product is safe, complies with application laws and regulations, and is technically or otherwise fit for its intended use. Seller does not endorse or claim suitability of its products for a specific application and disclaims each and every representation or warranty, whether express or implied, in that respect.

Typical values are indicative only and are not to be construed as being binding specifications. Colorants in the product or other additives may cause significant variations in typical values.

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